ABSOCIATION CONNECTING ELECTRONICE INDUSTRIES INTERNAL MALE INDUSTRIES INDUSTRIES INTO A CONNECTING INTERNAL OF A CONNECT	ekburn, Illinois, A	All rights reserved untions.	under both	This docume level parts, t	ent is a declarat	ion of the s encompasse	ubstances es all lowe	within the man er level materials	ufacturer liste s for which th	d item. Not e manufact	te: if the item turer has engi	n is an assem ineering resp	bly with lowe onsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Ty   http://www.ipc.org/IPC-175x Distribut			* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materia					Materials and	als and Mfg Information				
Supplier Information														
Company name* Company unique ID				Unique ID Authority					Resp	Response Date*				
ısemi										2024-04-25				
Contact Name	Title - Contact			]	Phone - Contact*				Emai	Email - Contact*				
roduct-Env-Stewards Product Enviro Compliance				NA					Prod	Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Representative				Phone - Representative*					Emai	Email - Representative*				
Product-Env-Stewards Product Enviro Complian				NA				Prod	Product-Env-Stewards@onsemi.com					
Requester Item Number Mfr I	em Number	Mfr Item Name			Effective Date	ate Version Manufacturing Site		lite	Weight*	* UO	M	Unit Type		
NCP	253MNTBG Synchronous Buck N		ck MOSFET Driv	ver	2024-04-25 THe		TH6		9.1	mg		Each		
Manufacturing Proccess Information											·			
Terminal Plating / Grid Array Material	Terminal Base Alloy J-S		J-STD-020 MSL	Rating	Peak Process Body Tempe		'emperatu	ture Max Time at Peak Ter		erature Nu	umber of Ref	flow Cycles		
Matte Tin (Sn) - annealed CU Alloy 1		1		260		С	30	see	conds 3					
Comments														
evel 1 - maximum time at peak temperature during	soldering is 10-3	0 seconds												
or more information regarding material composition	on please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).											
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of							
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted								
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all							
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the							
Supplier Digital Signature Ra	stislav Drska	Le										

## Homogeneous Material Composition Declaration for Electronic Products

sigma range of distribution unless otherwise noted).

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

Homogeneous Material Weight Unit of		Unit of Measure	Level Substance		CAS	Exempt	Weight	Unit of Measure	
Die	0.16	mg	Supplier	Silicon (Si)	7440-21-3		0.16	mg	
Die Attach	0.07	mg	Supplier	Epoxized Condensate Of Para- Hydrobenzaldehyde And Alkyl Phenol	129915-35-1		0.014	mg	
			Supplier	Silver (Ag)	7440-22-4		0.056	mg	
Lead Frame	3.71	mg	Supplier	Silver (Ag)	7440-22-4		0.0371	mg	
			Supplier	Zinc (Zn)	7440-66-6		0.0045	mg	
			Supplier	Iron (Fe)	7439-89-6		0.0872	mg	
			Supplier	Copper (Cu)	7440-50-8		3.5801	mg	
			Supplier	Phosphorus (P)	7723-14-0		0.0011	mg	
Mold Compound-Black	5.0	mg		Epoxy resin	proprietary data		0.25	mg	
			Supplier	Phenolic Resin	Proprietary Data		0.115	mg	
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.25	mg	
			Supplier	Carbon Black (C)	1333-86-4		0.02	mg	
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.115	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		4.25	mg	
Plating	0.14	mg	Supplier	Tin (Sn)	7440-31-5		0.14	mg	
Wire Bond	0.02	mg	Supplier	Palladium (Pd)	7440-05-3		0.0004	mg	
			Supplier	Gold (Au)	7440-57-5		0.0001	mg	
			Supplier	Copper (Cu)	7440-50-8		0.0195	mg	